Fractography of Borosilicate Glass Tested in Three- and Four-Point Bending

M. H. Dielhof
Section of Computational and Experimental Mechanics, Faculty of Mechanical Engineering, PO Box 513, 5600 MB Eindhoven, The Netherlands

L. J. M. G. Dortmans & G. de With*
Centre for Technical Ceramics, PO Box 595, 5600 AN Eindhoven, The Netherlands

(Received 2 February 1993; accepted 31 March 1993)

Abstract

Most studies dealing with fractographic analysis are based on the occurrence of features, such as mirror, mist and hackle zones, formed symmetrically around a defect. Calculations are carried out hereupon. In this study, polished borosilicate specimens, and ground, annealed and chamfered borosilicate glass specimens are used for fractography. Six defect types could be distinguished, whereof four types deviate from symmetry. The strength data, obtained from three- and four-point bending, are described by a Weibull probability density function. Discontinuities present in the Weibull graphs were expected to be linked to the six defect populations. However, although glass is assumed to be an ideal and isotropic material, no such relationship has been found.

1 Introduction

Fractography of brittle materials is used to determine the origin of failure during strength testing. In general, this origin can be traced to material inhomogeneities, such as pores and microcracks, which occur either due to material processing (volume defects) or machining (surface defects). Fracture features, such as mirror, mist and hackle zones, and crack branching, are formed upon failure. Generally it is assumed that these are formed symmetrically around the critical defect.1-5 Calculations to obtain material parameters, such as mirror constant and fracture toughness, are carried out with the assumption that symmetric fracture features occur.5,6-9

In a number of cases, the bimodal behaviour of a Weibull graph was associated with different types of failure origin, such as the distinction between...
Table 1. Properties and dimensions of the borosilicate glass samples

<table>
<thead>
<tr>
<th></th>
<th>Bars</th>
<th>Disk(^1)</th>
<th>Disk(^2)</th>
</tr>
</thead>
<tbody>
<tr>
<td>Dimensions (mm)</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>L = 50</td>
<td>D = 20</td>
<td>D = 30</td>
<td></td>
</tr>
<tr>
<td>H = 4.5</td>
<td>t = 1.5</td>
<td>t = 1.5</td>
<td></td>
</tr>
<tr>
<td>W = 3.5</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Tolerance on dimensions (mm)</td>
<td>0.1</td>
<td>0.1</td>
<td>0.1</td>
</tr>
<tr>
<td>Chamfer width (mm)</td>
<td>0.07</td>
<td></td>
<td>0.07</td>
</tr>
<tr>
<td>Roughness (µm)</td>
<td>&lt; 0.1</td>
<td>&lt; 0.3</td>
<td>&lt; 0.3</td>
</tr>
<tr>
<td>Flatness (µm)</td>
<td>&lt; 5</td>
<td>&lt; 5</td>
<td>&lt; 5</td>
</tr>
<tr>
<td>Density (g/cm(^3))</td>
<td>2.21</td>
<td>2.51</td>
<td>2.51</td>
</tr>
<tr>
<td>Poisson’s ratio(^a)</td>
<td>0.189</td>
<td>0.224</td>
<td>0.224</td>
</tr>
<tr>
<td>Young’s modulus (GPa)(^a)</td>
<td>61.6</td>
<td>71.3</td>
<td>71.3</td>
</tr>
</tbody>
</table>

\(^a\) Disk\(^1\) and disk\(^2\) represent the disks used for bor and ror respectively.

\(^b\) Measured with the pulse-echo technique.

volume defects and surface defects, but without significant support of fractography. It is, however, clear that such a correlation can be made unequivocally. Therefore, some tests were done, in order to verify such a one-to-one correlation. Three- and four-point bend tests were done, and the resulting strength data are described by means of Weibull statistics. The chosen test material was glass, because of its assumed ideal behaviour and isotropy. Fracture features are examined by means of optical and scanning electron microscopy. For both the polished and the ground, annealed and chamfered series the relationship between the defect types and Weibull statistics has been studied.

2 Experimental Procedure

Two series of borosilicate glass specimens were prepared. The first series was ground and afterwards polished. The second series was ground and afterwards annealed, to reduce residual compressive stresses in the specimen surface. The annealing temperature was chosen at 540°C (within the annealing range of 525°C and 550°C), to prevent deformation of the specimen due to weakening at the upper annealing temperature. Annealing at 540°C, representative for a viscosity of 10\(^{14.5}\) dPa, results in a stress reduction to about 0.6 MPa after 1 h annealing. Strength testing was done in three-point bending with span length 20 mm (3pb20) and 40 mm (3pb40), and four-point bending (4pb) with inner span length 20 mm and outer span length 40 mm, ball-on-ring (bor) bending with loading radius 6 mm, and ring-on-ring (ror) bending with inner loading radius 6 mm and outer loading radius 10 mm. The crosshead speed of the testing machines was chosen corresponding to a strain rate of 5 \(\times 10^{-4}\) s\(^{-1}\). Dry conditions were achieved by means of flushing nitrogen gas with a dew point of \(-35°C\) through a chamber enveloping the test jig. The fracture planes of the specimen tested in three- and four-point bending were examined by means of a Zeiss optical microscope with 30–40 times magnification. SEM examination was done by means of a JEOL JSM-800A scanning electron microscope. The properties and the dimensions of the glass specimens are listed in Table 1, where \(L\) is the length of the bars, \(H\) the height, \(W\) the width, \(D\) the diameter of the disks and \(t\) their thickness.

3 Results and Discussion

Strength results for the ground and polished series are given in Table 2. The strength distribution can be described by means of a Weibull probability distribution function. The Weibull distribution is calculated, according to\(^{10–12}\)

\[
P_f = 1 - \exp \left( -\frac{\sigma_f}{\sigma_0} \right)^m
\]

where \(P_f\) is the failure probability, \(\sigma_f\) is the failure strength, \(\sigma_0\) is the characteristic Weibull strength, and \(m\) is the Weibull modulus. The Weibull modulus is calculated, using a least-squares fit with a weight function on the linearized Weibull equation. The failure probability \(P_i\) is estimated by\(^{10–12}\)

\[
P_i = \frac{i - 0.5}{N}
\]

where \(N\) is the total number of specimens and \(i\) is the rank number. The weight function used was\(^{11,12}\)

\[w_i = [\left(1 - P_i\right) \ln (1 - P_i)]^2\]

For the polished series, the Weibull graph is shown.

Table 2. Results of the strength tests of the ground and polished borosilicate glass series

<table>
<thead>
<tr>
<th>Batch</th>
<th>N</th>
<th>Mean (\sigma_f) (MPa) ± SD</th>
<th>m</th>
<th>(\sigma_0) (MPa)</th>
</tr>
</thead>
<tbody>
<tr>
<td>bor</td>
<td>40</td>
<td>237.3 ± 51.3</td>
<td>5.0</td>
<td>242.6</td>
</tr>
<tr>
<td>3pb20</td>
<td>40</td>
<td>200.6 ± 29.9</td>
<td>10.9</td>
<td>213.3</td>
</tr>
<tr>
<td>3pb40</td>
<td>40</td>
<td>193.4 ± 21.8</td>
<td>10.8</td>
<td>202.9</td>
</tr>
<tr>
<td>4pb40</td>
<td>40</td>
<td>160.7 ± 34.4</td>
<td>5.2</td>
<td>177.9</td>
</tr>
<tr>
<td>ror</td>
<td>40</td>
<td>125.7 ± 31.0</td>
<td>3.4</td>
<td>134.5</td>
</tr>
</tbody>
</table>
Fractography of borosilicate glass

in Fig. 1. The Weibull graphs show a decrease in strength from bor towards 3pb20, towards 4pb40, towards ror, corresponding to the increase in effective (tested) surface.

Fractography revealed four distinct regions on the fracture surface, surrounding the critical defect. These regions are: from the defect growing outwards, a mirror zone (a flat and smooth region), a mist zone (small ridges parallel to the direction of crack propagation), a hackle zone (similar to the mist zone but larger ridges), and crack branching (the formation of two or more primary cracks), as is shown in Fig. 2.

In the literature, analysis of fracture surfaces has been carried out with the assumption that symmetric fracture features are formed around the strength-determining defect. The samples studied here show, however, that this is only true for 46% of the tested specimens of the polished series, and for 35% of the tested specimens of the annealed series. Six defect types could be distinguished. A description, assisted by SEM photographs, is given in Fig. 3.

The relationship between the defect types observed and the Weibull graphs is shown in Fig. 1 for the polished series. A decrease from high towards low strengths was expected to be followed by failure on type 1 defects at high strengths, from type 2 and 3 defects at intermediate strengths, and from type 5 and 6 defects at low strengths. Such a relationship, however, has not been found. The defects seem to be distributed randomly. This poor relationship was considered to be the result of residual compressive stresses on the specimen surface, caused by grinding and polishing.

Annealing is capable of removing the residual stress. However, it can possibly also affect the defect size distribution. Therefore, the effect of annealing upon Weibull statistics is studied. The Weibull modulus $m$ is 3.6 (20 specimens tested in 3pb20) for the annealed series, and 5.5 (20 specimens tested in
Fig. 3. Representative SEM photographs of the six defect types. The small white arrows show the defect (1), mirror (2), mist (3) and hackle zone (4) and crack branching (5). The large white arrows show the direction of maximum tensile stress. (a) The mirror is formed symmetrically around a surface defect (type 1), along the side of the bar of maximum tensile stress; (b) the mirror is formed strongly asymmetrically around a surface defect (type 2), along the side of the bar of maximum tensile stress; (c) the mirror is formed around several surface defects (type 3), which are located along the side of the bar of maximum tensile stress; (d) a volume defect (type 4), formed due to processing inhomogeneities; (e) a type 5 defect, which is located on the side of the bar; and (f) a type 6 defect, which is located at the chamfered edge.

3pb20) for the non-annealed series. The 95% probability interval for $m$ for 20 samples is $4.6 \pm 0.5$. Annealing seems not to affect the defect populations significantly, as shown by the similar Weibull modulus for annealed and non-annealed ground specimens.

Results for the ground and annealed specimens showed strength data for 4pb samples below or tested samples, which was not expected, according to the effective tested surface of both tests. Fractography on 4pb and 3pb20 tested samples indicated that 54% of all tested samples failed on about 10 μm
Table 3. Strength results of the annealed and chamfered borosilicate glass series

<table>
<thead>
<tr>
<th>Batch</th>
<th>N</th>
<th>Mean $\sigma_i$ (MPa)</th>
<th>$m$</th>
<th>$\sigma_o$ (MPa)</th>
</tr>
</thead>
<tbody>
<tr>
<td>3pb20</td>
<td>30</td>
<td>237.8 ± 47.0</td>
<td>6.2</td>
<td>259.8</td>
</tr>
<tr>
<td>bor</td>
<td>30</td>
<td>243.4 ± 56.6</td>
<td>4.5</td>
<td>262.7</td>
</tr>
<tr>
<td>4pb40/20</td>
<td>30</td>
<td>180.4 ± 49.8</td>
<td>3.8</td>
<td>205.6</td>
</tr>
<tr>
<td>ror</td>
<td>30</td>
<td>125.7 ± 31.0</td>
<td>3.4</td>
<td>134.5</td>
</tr>
</tbody>
</table>

A decrease of type 1 defects is found from 47% for 3pb20, towards 23% for 4pb. This behaviour is followed by an increase in effective tested surface from three-point bending towards four-point bending. The larger the effective tested surface becomes, the more other than ideal (type 1) defects are present.

4 Conclusions

In spite of the ideal and isotropic behaviour of glass, in which the defects can be traced and classified very well, no relationship has been found for the polished series and the annealed and chamfered series between the observed defect types and Weibull statistics. Therefore, the identification of different failure origins from Weibull graphs alone without fractography is useless. Fractographic studies on less ideal and more crystalline materials will be more difficult. The poor relationship between Weibull statistics and the observed defect types of the polished series cannot be ascribed to compressive residual stresses on the specimen surface only, because the annealed series show a comparable poor relationship. Annealing is considered not to affect the defect populations caused by grinding. The type 6 defects along the edges of the test bars, which are assumed to reduce the failure strength, could only
partly be removed by means of chamfering. They are absent in the polished series as a result of the polishing step.

References


Bibliography